836LFNC

Chemicals

Lead-Free No-Clean Flux

836LFNC is a halogen-free, low-activity, organic soldering flux for electronics. It has a low solids content and leaves virtually no residue. Solder joints appear shiny after soldering, even without cleaning.

This liquid flux is designed for wave soldering and surface mount assembly. It may be applied by spray or foam, or wave fluxing. It is also re-flowable in air or nitrogen.

In liquid format, we also offer rosin-based flux, no-clean, halogen-free flux, and lead-free water soluble flux.

For paste flux, visit MG Chemicals' 8341 and 8342.

Features & Benefits

- · Lead-free liquid flux
- Meets IPC J-STD-004B
- · For both leaded and lead-free solders
- Fast wetting
- No need to clean flux residue after soldering
- · Rosin/resin free
- · Halogen-free
- · RoHS-compliant

Available Packaging

Cat. No.PackagingNet Vol.Net Wt.836LFNC-1LBottle1 L810 g

Contact Information

MG Chemicals, 1210 Corporate Drive Burlington, Ontario, Canada L7L 5R6

Email: support@mgchemicals.com

Phone: North America: +(1)800-340-0772

International: +(1) 905-331-1396 Europe: +(44)1663 362888

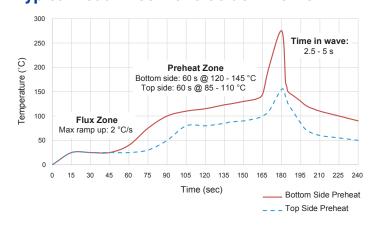


Properties

Flux Classification	ORL0
Flux Type	Organic
Flux Activity	Low
Copper Mirror	Pass

Cleaning Requirements Recommended Acid Number (mgKOH/g sample) 14–16 Halides (by weight) <0.5% Suface Insulation Resistance (SIR) 2.1 x $10^9~\Omega$

Typical Lead-Free Wave Solder Profile



836LFNC



Application Instructions

Read the product SDS before using this product (downloadable at www.mgchemicals.com).

- **1.** Apply flux on the surface by dip, spray, foam, or brush application.
- **2.** Clean residue with MG 413B, 413C, 4140, 4050A, or 4140A flux removers.

Wave Solder Operating Parameters

Amount of Flux:

Foam	1000-2000 μg/in ² solids
Spray	750-1500 µg/in ² solids

Foam Fluxing Parameters:

20–50 μm
25-40 mm
10-13 mm
1–2 lb/in ²

Top Side Preheat Temp. 85–110 °C

Bottom Side Preheat Temp. 35 °C

Conveyor-speed 1.2– 2.8 m/min

Contact Time in Solder 2.5–4.5 s

Solder Pot Temp.

Sn96.5/Ag3.5	260–276 °C
Sn95/Ag5	280-296 °C
Sn99.3/Cu0.7	265–276 °C
SnAgCu	271–276 °C
Sn95/Sb5	280-296 °C

Foam Flux

- The foam fluxer should be provided with the compressed air
- · Flux tank must be always full
- Surface of the flux should be 0.5–1" above the top of the flux aerator or flux stone
- Adjust pressure to optimize foam height with a fine uniform foam head
- After fluxing, use an air knife to remove excess flux from the machine

To check for uniformity of spray flux coating, run a tempered glass plate provided by the machine manufactuer through the flux and preheat zones. Ensure to inspect the glass before the wave zone.

Storage and Handling

Store between 18 and 27 °C in a dry area, away from sunlight (see SDS).

Disclaimer

This information is believed to be accurate. It is intended for professional end-users who have the skills required to evaluate and use the data properly. M.G. Chemicals Ltd. does not guarantee the accuracy of the data and assumes no liability in connection with damages incurred while using it.